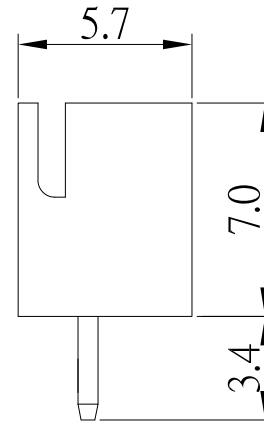
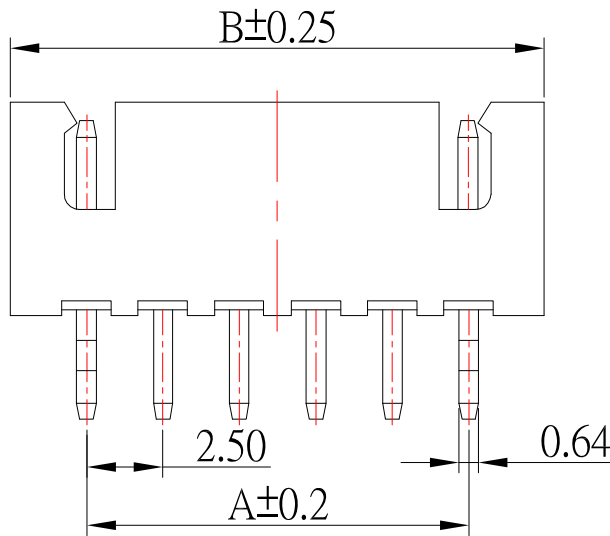


P.C.B LAYOUT MOUNTING PATTERN

	DIM. A	DIM. B
2	2.50	7.50
3	5.00	10.00
4	7.50	12.50
5	10.00	15.00
6	12.50	17.50
7	15.00	20.00
8	17.50	22.50
9	20.00	25.00
10	22.50	27.50
11	25.00	30.00
12	27.50	32.50
13	30.00	35.00
14	32.50	37.50
15	35.00	40.00
16	37.50	42.50
17	40.00	45.00
18	42.50	47.50
19	45.00	50.00
20	47.50	52.50



SPECIFICATIONS

1. Current rating : 3.0A
2. Temperature rating : -25°C ~ +85°C
3. Insulation resistance : 1000MΩ min.
4. Contact resistance : 20mΩ / Max

Material:

Housing : PA66

Contact : Brass , Tin plated over Nickel

8	更新尺寸位置	Jack	070523
7	新增尺寸	Jack	070323
6	更新圖面	Jack	080922
5	新增尺寸	Jack	081320
4	更新樣式	Lan	041819
3	更新圖面	Jack	040219
2	更新尺寸	Jack	062917
1	更新材質	Jack	041116
ITEM NO.	DESCRIPTION	DRAWN	DATE

東莞市高迪電子有限公司
DONG GUAN GAO DI ELECTRONICS CO., LTD

TOLERANCE UNLESS OTHERWISE STATED :

Up to 5	±0.2
Above 5 ~ 15	±0.3
Above 15 ~ 30	±0.4
Above 30 ~ 50	±0.5
Angle	±0.3

3RD. ANGEL'S



UNITS MM

DRAWN BY:	DATE	MAT'L	TITLE	CONNECTOR
Jack Lu	07/05/23		MODLE	2.54 WAFER 180度 H:7.0mm
CHECKED BY:	DATE	FINISH	SCALE	1 : 1
Jacky Chen	07/05/23		DWG NO.	WF-2501VDxx-S304
APPROVED BY:	DATE	SHEET NO.	PART NO.	WF-2501VDxx-S304
Tony Kao	07/05/23	1 of 1		

SIZE	A4
VER	R8